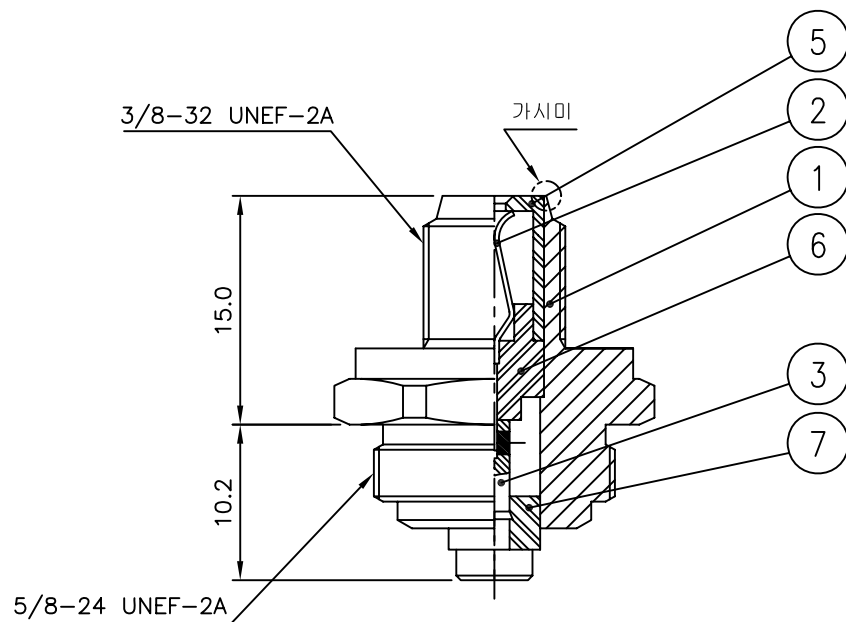
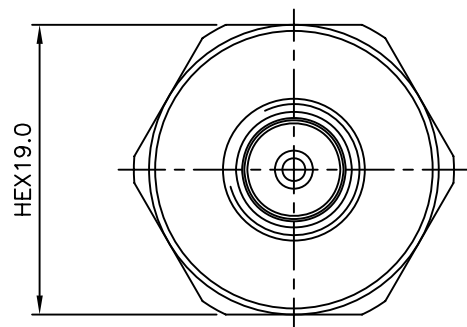
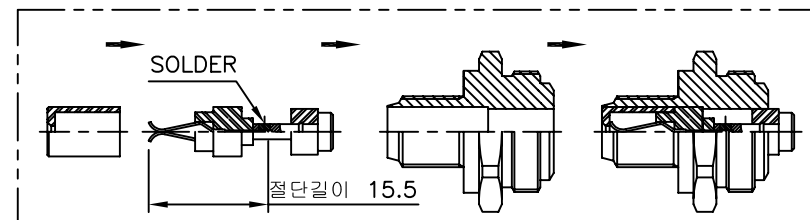




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2017.07.03.
1	[설번No.201801-0014] 고객사 요청으로 인한 부품삭제	S.Y.EUN	I.C.KIM	2018.01.25.



조립순서

1. ②번 PIN을 길이에 맞게 절단한다.
2. ③번 PIN과 ⑦번 절연체를 조립한다.
3. ②번 PIN과 ③번 PIN을 위 그림처럼 연결 후 납땜처리한다.
4. ③번 조립품을 ①번 BODY에 끼워넣고 ⑤번 절연체를 조립 후 가시미 작업한다.

1	8	INSULATOR	1	ACETAL		DIN02911-N/1
	7	INSULATOR	1	TEFLON		DIN02910-N/1
	6	INSULATOR	1	P.P		DIN02007-N/1
	5	INSULATOR	1	P.P		DIN02006-N/1
1	4	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT03853-5/2
	3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT03852-5/1
	2	CONTACT	1	PBS	Gold Plate	DCT02593-5/4
	1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04327-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2018. 01. 25.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE F75 SOLDER END JB (F/F)
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	UNIT	DWG NO. CN03705-7/1 REVISION 1 SHEET 1 of 1
		2/1	mm	